

TOSHIBA Power Transistor Module Silicon NPN&PNP Epitaxial Type
(Four Darlington Power Transistors in One)

MP4503

High Power Switching Applications

Hammer Drive, Pulse Motor Drive and Inductive Load
Switching

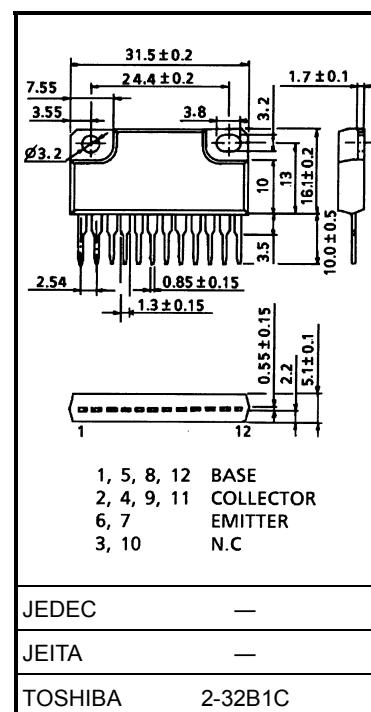
- Package with heat sink isolated to lead (SIP 12 pins)
- High collector power dissipation (4-device operation)
: PT = 5 W (Ta = 25°C)
- High collector current: IC (DC) = ±4 A (max)
- High DC current gain: hFE = 2000 (min) (VCE = ±2 V, IC = ±1 A)

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating		Unit
			NPN	PNP	
Collector-base voltage		V _{CBO}	100	-100	V
Collector-emitter voltage		V _{CEO}	80	-80	V
Emitter-base voltage		V _{EBO}	5	-5	V
Collector current	DC	I _C	4	-4	A
	Pulse	I _{CP}	6	-6	
Continuous base current		I _B	0.4	-0.4	A
Collector power dissipation (1-device operation)		P _C	3.0		W
Collector power dissipation (4-device operation)	T _a = 25°C	P _T	5.0		W
	T _c = 25°C		25		
Isolation voltage		V _{Isol}	1000		V
Junction temperature		T _j	150		°C
Storage temperature range		T _{stg}	-55 to 150		°C

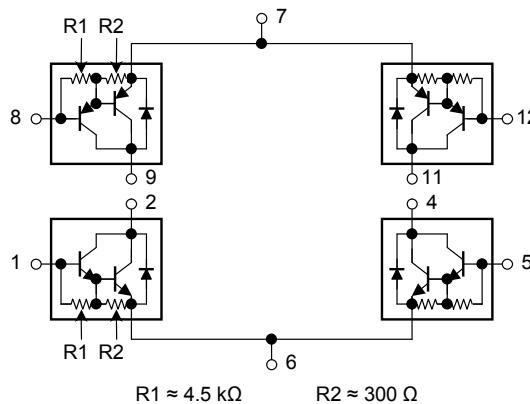
Industrial Applications

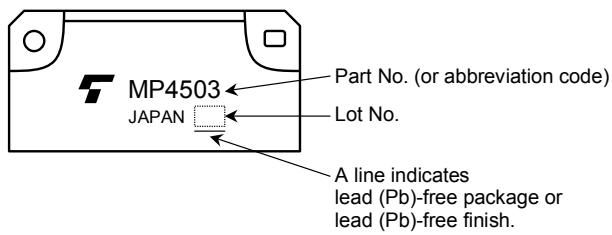
Unit: mm



Weight: 6.0 g (typ.)

Array Configuration



Marking**Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance of junction to ambient (4-device operation, $T_a = 25^\circ\text{C}$)	$\Sigma R_{th} (j-a)$	25	$^\circ\text{C}/\text{W}$
Thermal resistance of junction to case (4-device operation, $T_c = 25^\circ\text{C}$)	$\Sigma R_{th} (j-c)$	5.0	$^\circ\text{C}/\text{W}$
Maximum lead temperature for soldering purposes (3.2 mm from case for 10 s)	T_L	260	$^\circ\text{C}$

Electrical Characteristics ($T_a = 25^\circ\text{C}$) (NPN transistor)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	I_{CBO}	$V_{CB} = 100 \text{ V}, I_E = 0 \text{ A}$	—	—	20	μA
Collector cut-off current	I_{CEO}	$V_{CE} = 80 \text{ V}, I_B = 0 \text{ A}$	—	—	20	μA
Emitter cut-off current	I_{EBO}	$V_{EB} = 5 \text{ V}, I_C = 0 \text{ A}$	0.5	—	2.5	mA
Collector-base breakdown voltage	$V_{(BR)} CBO$	$I_C = 1 \text{ mA}, I_E = 0 \text{ A}$	100	—	—	V
Collector-emitter breakdown voltage	$V_{(BR)} CEO$	$I_C = 10 \text{ mA}, I_B = 0 \text{ A}$	80	—	—	V
DC current gain	$h_{FE} (1)$	$V_{CE} = 2 \text{ V}, I_C = 1 \text{ A}$	2000	—	—	—
	$h_{FE} (2)$	$V_{CE} = 2 \text{ V}, I_C = 3 \text{ A}$	1000	—	—	
Saturation voltage	$V_{CE (\text{sat})}$	$I_C = 3 \text{ A}, I_B = 6 \text{ mA}$	—	—	1.5	V
	$V_{BE (\text{sat})}$	$I_C = 3 \text{ A}, I_B = 6 \text{ mA}$	—	—	2.0	
Transition frequency	f_T	$V_{CE} = 2 \text{ V}, I_C = 0.5 \text{ A}$	—	60	—	MHz
Collector output capacitance	C_{ob}	$V_{CB} = 10 \text{ V}, I_E = 0 \text{ A}, f = 1 \text{ MHz}$	—	30	—	pF
Switching time	Turn-on time	t_{on}	—	0.2	—	μs
	Storage time	t_{stg}	—	1.5	—	
	Fall time	t_f	—	0.6	—	

Switching time waveforms:

$I_B1 = -I_B2 = 6 \text{ mA}$, duty cycle $\leq 1\%$

Emitter-Collector Diode Ratings and Characteristics ($T_a = 25^\circ\text{C}$)

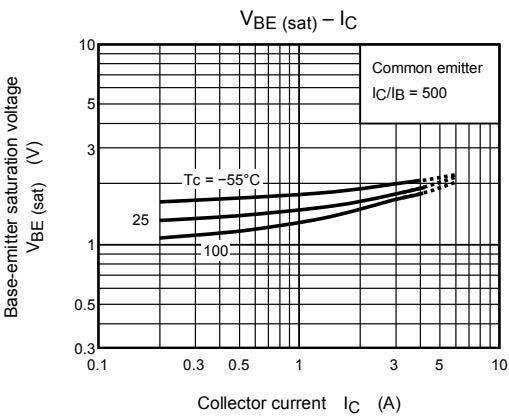
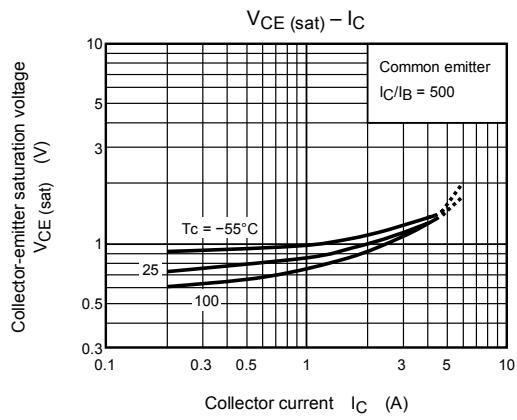
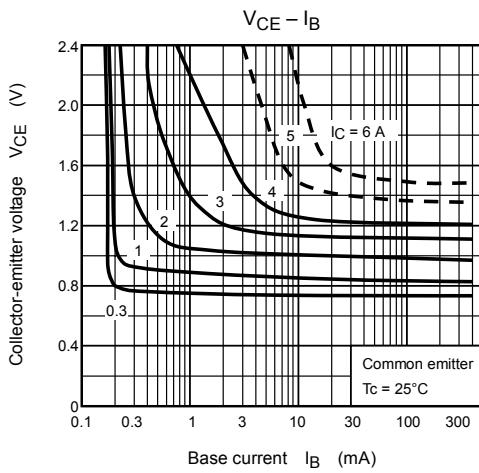
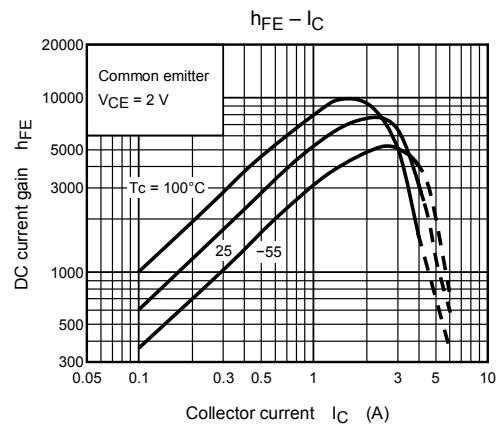
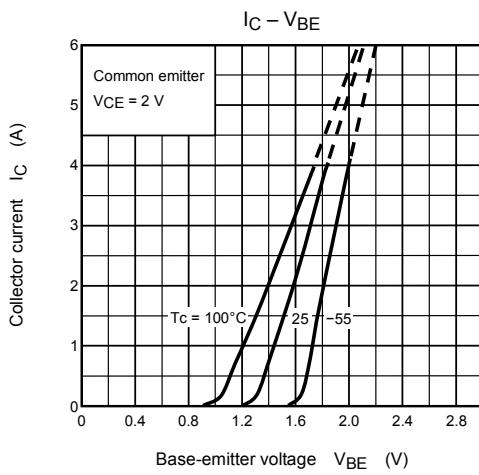
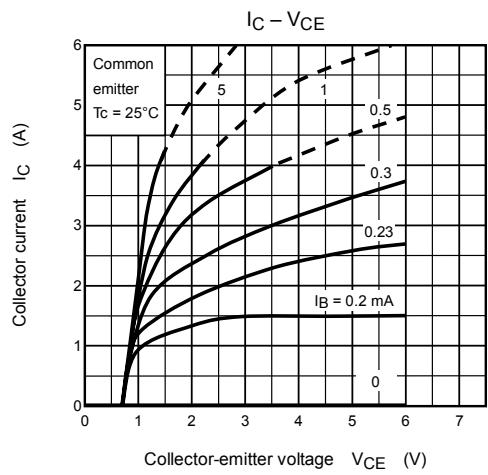
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward current	I_{FM}	—	—	—	4	A
Surge current	I_{FSM}	$t = 1 \text{ s}, 1 \text{ shot}$	—	—	6	A
Forward voltage	V_F	$I_F = 1 \text{ A}, I_B = 0 \text{ A}$	—	—	2.0	V
Reverse recovery time	t_{rr}	$I_F = 4 \text{ A}, V_{BE} = -3 \text{ V}, dI_F/dt = -50 \text{ A}/\mu\text{s}$	—	1.0	—	μs
Reverse recovery charge	Q_{rr}		—	8	—	μC

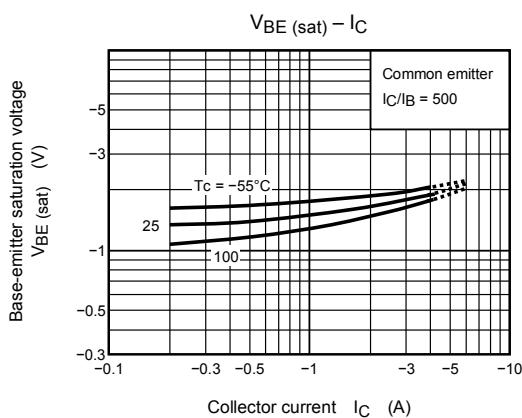
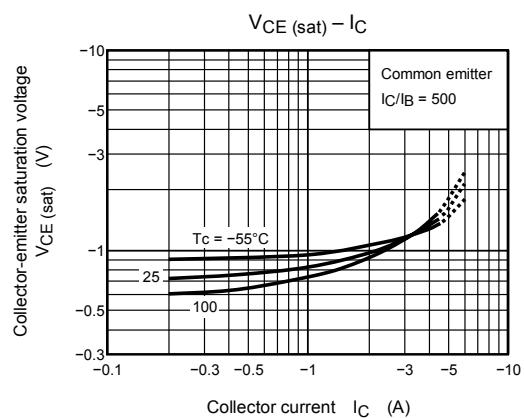
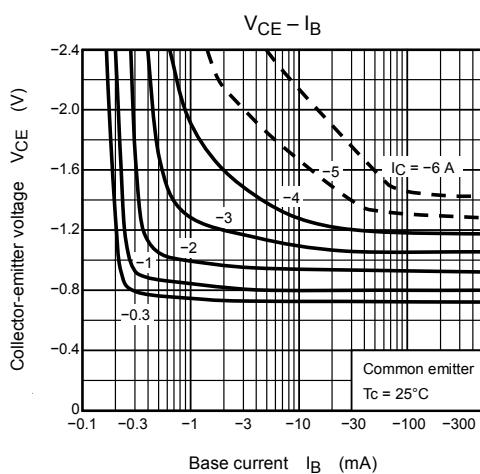
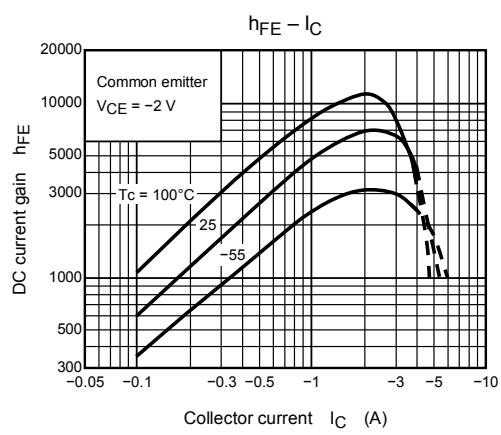
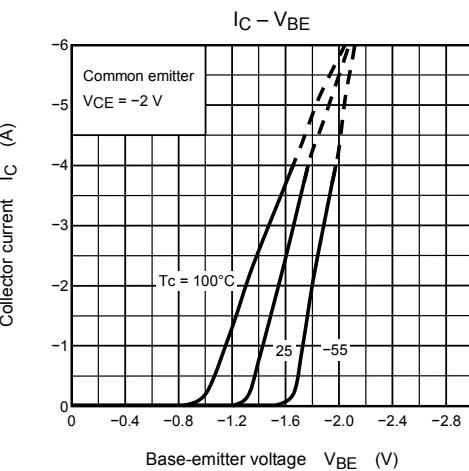
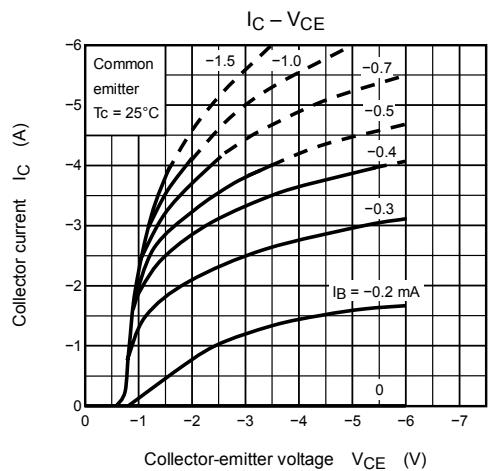
Electrical Characteristics ($T_a = 25^\circ\text{C}$) (PNP transistor)

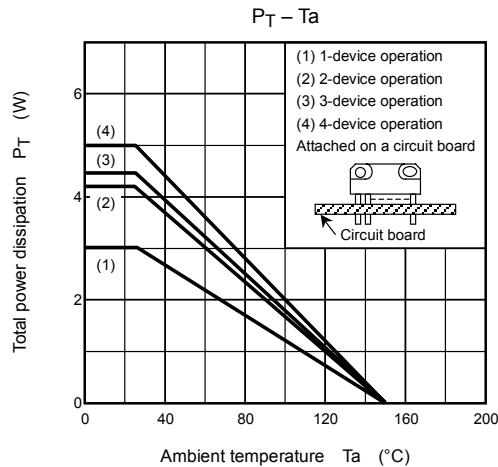
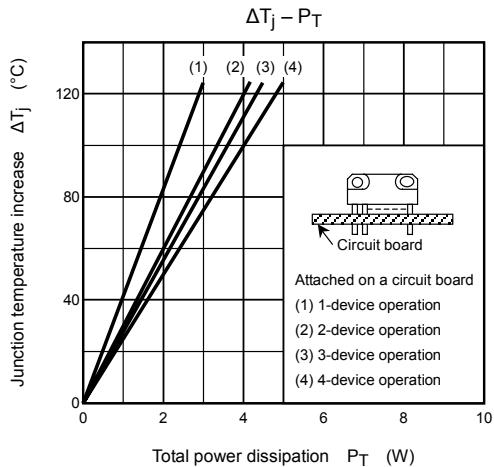
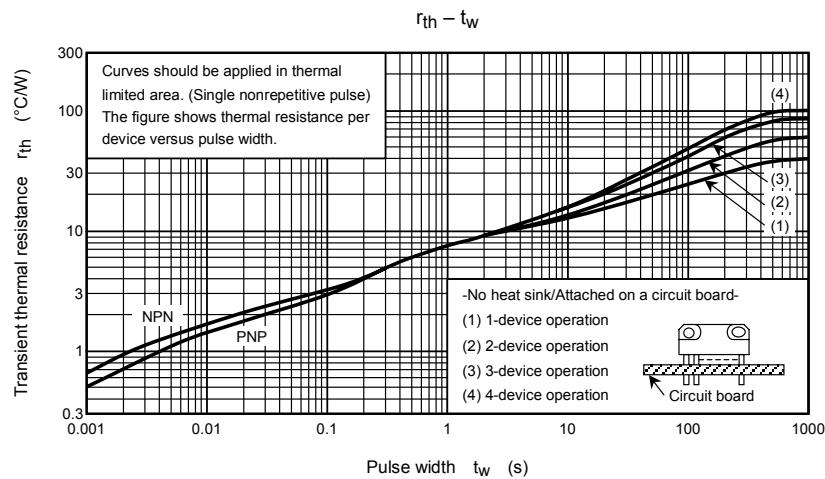
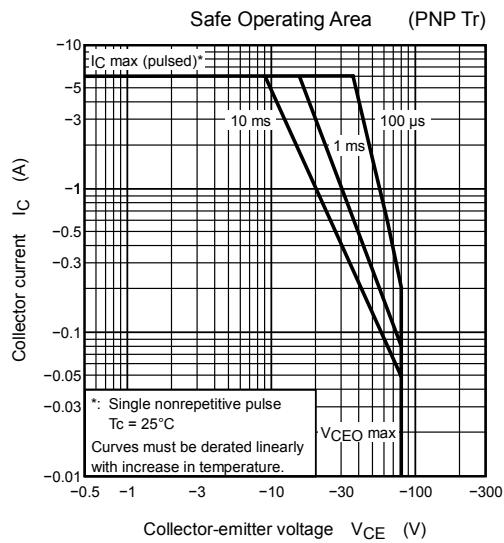
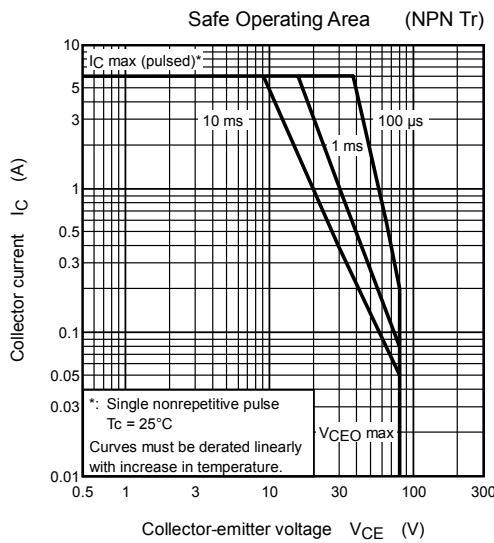
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	I_{CBO}	$V_{CB} = -100 \text{ V}, I_E = 0 \text{ A}$	—	—	-20	μA
Collector cut-off current	I_{CEO}	$V_{CE} = -80 \text{ V}, I_B = 0 \text{ A}$	—	—	-20	μA
Emitter cut-off current	I_{EBO}	$V_{EB} = -5 \text{ V}, I_C = 0 \text{ A}$	-0.5	—	-2.5	mA
Collector-base breakdown voltage	$V_{(BR) CBO}$	$I_C = -1 \text{ mA}, I_E = 0 \text{ A}$	-100	—	—	V
Collector-emitter breakdown voltage	$V_{(BR) CEO}$	$I_C = -10 \text{ mA}, I_B = 0 \text{ A}$	-80	—	—	V
DC current gain	$h_{FE} (1)$	$V_{CE} = -2 \text{ V}, I_C = -1 \text{ A}$	2000	—	—	—
	$h_{FE} (2)$	$V_{CE} = -2 \text{ V}, I_C = -3 \text{ A}$	1000	—	—	—
Saturation voltage	Collector-emitter	$V_{CE} (\text{sat})$	$I_C = -3 \text{ A}, I_B = -6 \text{ mA}$	—	—	-1.5
	Base-emitter	$V_{BE} (\text{sat})$	$I_C = -3 \text{ A}, I_B = -6 \text{ mA}$	—	—	-2.0
Transition frequency	f_T	$V_{CE} = -2 \text{ V}, I_C = -0.5 \text{ A}$	—	40	—	MHz
Collector output capacitance	C_{ob}	$V_{CB} = -10 \text{ V}, I_E = 0 \text{ A}, f = 1 \text{ MHz}$	—	55	—	pF
Switching time	Turn-on time	t_{on}	 $t_{on} = 0.15 \mu\text{s}$			
	Storage time	t_{stg}	$t_{stg} = 0.80 \mu\text{s}$			
	Fall time	t_f	$t_f = 0.40 \mu\text{s}$			

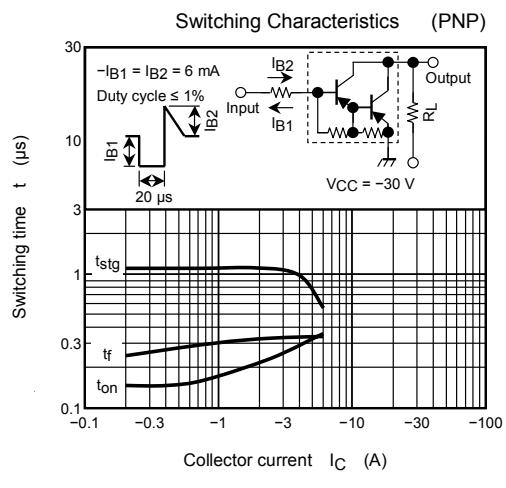
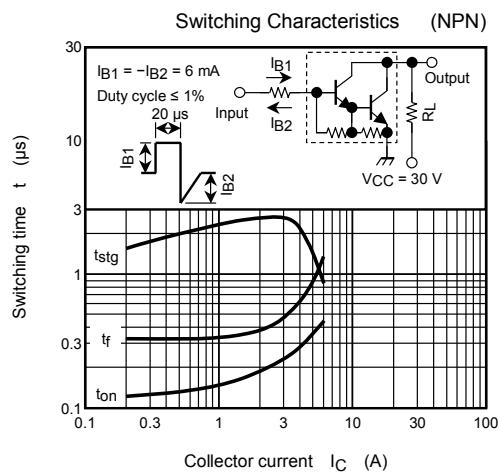
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Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward current	I_{FM}	—	—	—	4	A
Surge current	I_{FSM}	$t = 1 \text{ s}, 1 \text{ shot}$	—	—	6	A
Forward voltage	V_F	$I_F = 1 \text{ A}, I_B = 0 \text{ A}$	—	—	2.0	V
Reverse recovery time	t_{rr}	$I_F = 4 \text{ A}, V_{BE} = 3 \text{ V}, dI_F/dt = -50 \text{ A}/\mu\text{s}$	—	1.0	—	μs
Reverse recovery charge	Q_{rr}		—	8	—	μC









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